502707775 03/05/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2754380

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YOSHIRO HIROSE	02/25/2014
RYUJI YAMAMOTO	02/26/2014
ATSUSHI SANO	02/25/2014

RECEIVING PARTY DATA

Name:	Hitachi Kokusai Electric Inc.
Street Address:	14-1, Sotokanda 4-chome
Internal Address:	Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	1018980

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14197920

CORRESPONDENCE DATA

 Fax Number:
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Correspondent Name: VOLPE AND KOENIG, P.C. Address Line 1: 30 SOUTH 17TH STREET

Address Line 2: UNITED PLAZA

Address Line 4: PHILADELPHIA, PENNSYLVANIA 19103

ATTORNEY DOCKET NUMBER:	HITACHI13-0000275US01
NAME OF SUBMITTER:	DANIEL N. CALDER

PATENT REEL: 032357 FRAME: 0178

Signature:	/Daniel N. Calder/
Date:	03/05/2014
Total Attachments: 5 source=0000275US01_Assignment_EFS#p source=0000275US01_Assignment_EFS#p source=0000275US01_Assignment_EFS#p source=0000275US01_Assignment_EFS#p source=0000275US01_Assignment_EFS#p	age2.tif age3.tif age4.tif

PATENT REEL: 032357 FRAME: 0179

ASSIGNMENT AND DECLARATION

With respect to the invention titled

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE. SUBSTRATE PROCESSING APPARATUS, AND RECORDING MEDIUM

for	whi	ich the	undersig	ned ha	is auth	orized or	prep	ared	an	application	for	United
Sta	ites	Letters	Patent,	U.S.	Patent	Applicat	ion N	Vo	/19	7,920		_ filed
on.	Marc	eh 5, 20	1.4									

I (the undersigned) hereby state the following.

DECLARATION

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than 5 years, or both.

ASSIGNMENT

The undersigned hereby authorizes assignee or assignee's representative to insert the Application Number and the filing date of this application if they are unknown at the time of execution of this assignment.

Assignee	HITACHI KOKUSAI ELECTRIC INC.

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Attv. Docket No. HITACHI13-0000275US01

Assignee	State	or•	Country
of Incorp	oratio	n.	

Japan

Assignee Address

14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 1018980, Japan

Assignee is desirous of acquiring the entire right, title and interest in the invention, all applications for and all letters patent issued on the invention.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee and assignee's successors, assigns and legal representatives the entire right, title and interest in the invention and all patent applications thereon, including, but not limited to, the application for United States Letters Patent entitled as above, and all divisions and continuations thereof, and in all letters patent, including all reissues and reexaminations thereof, throughout the world, including the right to claim priority under the Paris Convention or other treaty.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, to supply all information and evidence relating to the making and practice of the invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention throughout the world for the benefit of the assignee, and to execute all instruments proper to carry out the intent of this instrument.

The undersigned warrants that the rights and property herein conveyed are free and clear of any encumbrance.

AND this Assignment may be executed in multiple counterparts, each of which shall be deemed to be an original of this Assignment. Additionally, the undersigned hereby authorizes our attorneys to collect the signature pages of each executed counterpart and to attach those signature pages to a single copy of this instrument, which single copy and attached signature pages together shall constitute an original of this Assignment.

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SIGNATURE SHEET FOR DECLARATION AND ASSIGNMENT

Inventor's Name	HIROSE, Yoshiro
Inventor's Signature	Hirose Yushiro
Date	February 25, 2014
Signed at	Toyama-shi, Japan
~	(City and Country)
STATEME	ENT OF WITNESS (optional):
	Ι,
	Name of Witness
was perso	nally present and did see HIROSE, Yoshiro
	inventor identified above
execute th	is Assignment on and such Assignor is personally know date
to me to b	e the person described herein.
Witness Signature	
must accom	ion data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, pany this form. Use a separate form for each inventor; or check the box below and attached page(s) to list additional inventors.

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■ Additional inventors are being named on the 2 supplemental sheet(s) attached hereto.

SUPPLEMENTAL SHEET FOR DECLARATION AND ASSIGNMENT

Inventor's Name	YAMAMOTO, Ryuji	
Inventor's Signature	Jamamoto Ryuji February 26, 2014	,
Date	February 26, 2014	
Signed at	Kodaira-shi, Japan	
	(City and Country)	
STATEM	ENT OF WITNESS (option	nal):
	I,	
		Name of Witness
was perso	onally present and did see	YAMAMOTO, Ryuji
	•	inventor identified above
execute t	his Assignment on d	and such Assignor is personally known
to me to l	be the person described here	in.
Witness Signature		

SUPPLEMENTAL SHEET FOR DECLARATION AND ASSIGNMENT

Inventor's Name	SANO, Atsushi	····
Inventor's Signature	Sano, Atsushi	
Date	Sano, Atsushi February 25, 2014	u
Signed at	Toyama-shi, Japan	
•	(City and Country)	
STATEME	IENT OF WITNESS (optional):	
	I,	
	Name of Witness	
was perso	sonally present and did see SANO, Atsushi	
	inventor identified above	
execute th	this Assignment on and such Assignor is p	ersonally knowr
to me to b	be the person described herein.	
Witness Signature		

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